

## 阅读申明

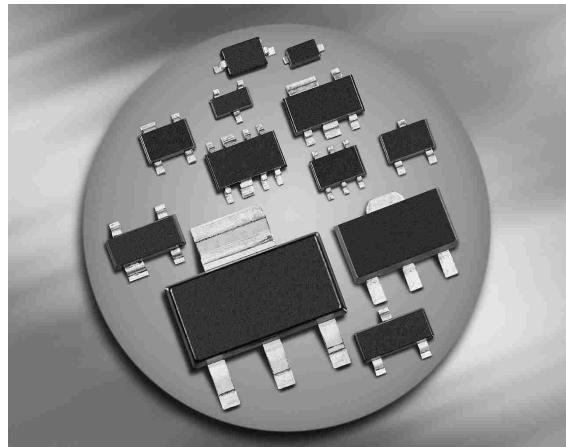
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### NPN Silicon AF Transistors

- For AF driver and output stages
- High collector current
- Low collector-emitter saturation voltage
- Complementary types: BCP51...BCP53 (PNP)
- Pb-free (RoHS compliant) package
- Qualified according AEC Q101



Type	Marking	Pin Configuration						Package
BCP54	*	1=B	2=C	3=E	4=C	-	-	SOT223
BCP54-16	*	1=B	2=C	3=E	4=C	-	-	SOT223
BCP55	*	1=B	2=C	3=E	4=C	-	-	SOT223
BCP55-16	*	1=B	2=C	3=E	4=C	-	-	SOT223
BCP56-10	*	1=B	2=C	3=E	4=C	-	-	SOT223
BCP56-16	*	1=B	2=C	3=E	4=C	-	-	SOT223

\* Marking is the same as the type-name

**Maximum Ratings**

Parameter	Symbol	Value	Unit
Collector-emitter voltage BCP54	$V_{CEO}$	45	V
BCP55		60	
BCP56		80	
Collector-base voltage BCP54	$V_{CBO}$	45	
BCP55		60	
BCP56		100	
Emitter-base voltage	$V_{EBO}$	5	
Collector current	$I_C$	1	A
Peak collector current, $t_p \leq 10 \text{ ms}$	$I_{CM}$	1.5	
Base current	$I_B$	100	mA
Peak base current	$I_{BM}$	200	
Total power dissipation- $T_S \leq 120^\circ\text{C}$	$P_{tot}$	2	W
Junction temperature	$T_j$	150	$^\circ\text{C}$
Storage temperature	$T_{stg}$	-65 ... 150	

**Thermal Resistance**

Parameter	Symbol	Value	Unit
Junction - soldering point <sup>1)</sup>	$R_{thJS}$	$\leq 15$	K/W

<sup>1</sup>For calculation of  $R_{thJA}$  please refer to Application Note AN077 (Thermal Resistance Calculation)

**Electrical Characteristics at  $T_A = 25^\circ\text{C}$ , unless otherwise specified**

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
<b>DC Characteristics</b>					
Collector-emitter breakdown voltage $I_C = 10 \text{ mA}, I_B = 0$ , BCP54...	$V_{(\text{BR})\text{CEO}}$	45	-	-	V
$I_C = 10 \text{ mA}, I_B = 0$ , BCP55...		60	-	-	
$I_C = 10 \text{ mA}, I_B = 0$ , BCP56-10, -16		80	-	-	
Collector-base breakdown voltage $I_C = 100 \mu\text{A}, I_E = 0$ , BCP54...	$V_{(\text{BR})\text{CBO}}$	45	-	-	
$I_C = 100 \mu\text{A}, I_E = 0$ , BCP55...		60	-	-	
$I_C = 100 \mu\text{A}, I_E = 0$ , BCP56-10, -16		100	-	-	
Emitter-base breakdown voltage $I_E = 10 \mu\text{A}, I_C = 0$	$V_{(\text{BR})\text{EBO}}$	5	-	-	
Collector-base cutoff current $V_{CB} = 30 \text{ V}, I_E = 0$	$I_{\text{CBO}}$	-	-	0.1	$\mu\text{A}$
$V_{CB} = 30 \text{ V}, I_E = 0, T_A = 150^\circ\text{C}$		-	-	20	
DC current gain <sup>1)</sup> $I_C = 5 \text{ mA}, V_{CE} = 2 \text{ V}$	$h_{\text{FE}}$	25	-	-	-
$I_C = 150 \text{ mA}, V_{CE} = 2 \text{ V}$ , BCP54/BCP55		40	-	250	
$I_C = 150 \text{ mA}, V_{CE} = 2 \text{ V}$ , BCP56-10		63	100	160	
$I_C = 150 \text{ mA}, V_{CE} = 2 \text{ V}$ , BCP54-16...BCP56-16		100	160	250	
$I_C = 500 \text{ mA}, V_{CE} = 2 \text{ V}$		25	-	-	
Collector-emitter saturation voltage <sup>1)</sup> $I_C = 500 \text{ mA}, I_B = 50 \text{ mA}$	$V_{\text{CEsat}}$	-	-	0.5	V
Base-emitter voltage <sup>1)</sup> $I_C = 500 \text{ mA}, V_{CE} = 2 \text{ V}$	$V_{\text{BE}(\text{ON})}$	-	-	1	

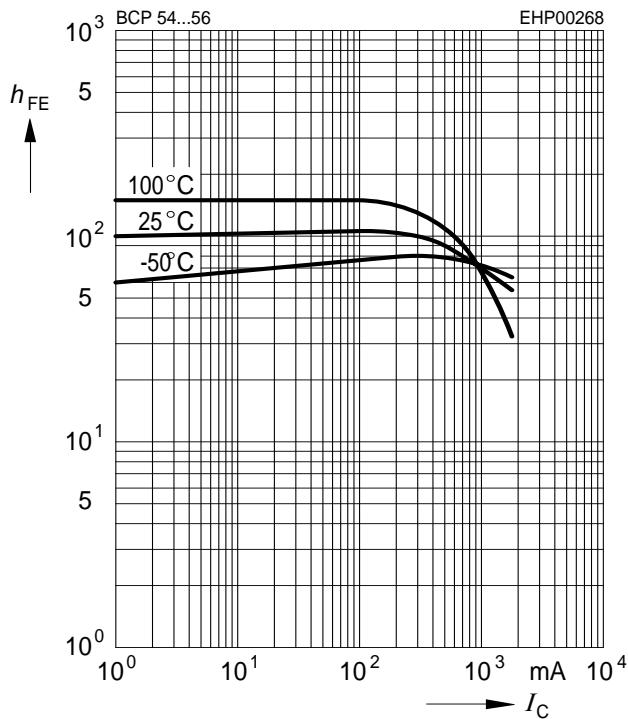
**AC Characteristics**

Transition frequency $I_C = 50 \text{ mA}, V_{CE} = 10 \text{ V}, f = 100 \text{ MHz}$	$f_T$	-	100	-	MHz
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<sup>1)</sup>Pulse test:  $t < 300\mu\text{s}$ ;  $D < 2\%$

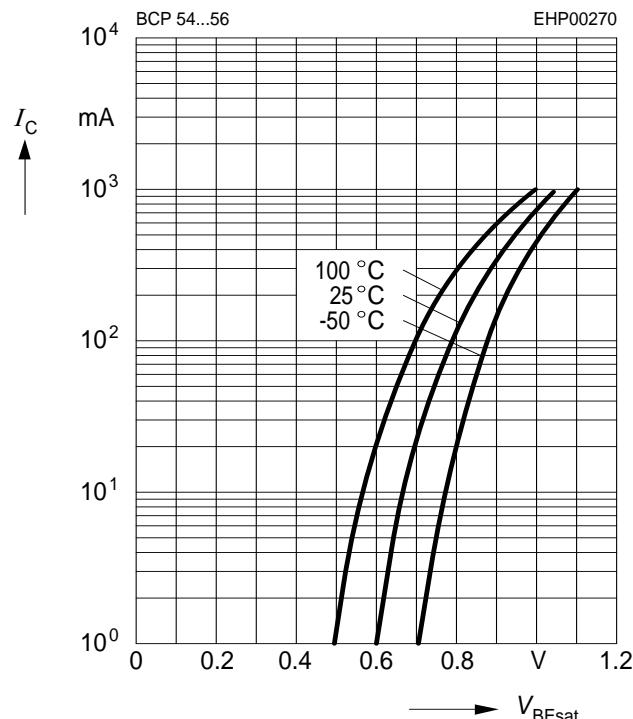
**DC current gain  $h_{FE} = f(I_C)$**

$V_{CE} = 2 \text{ V}$



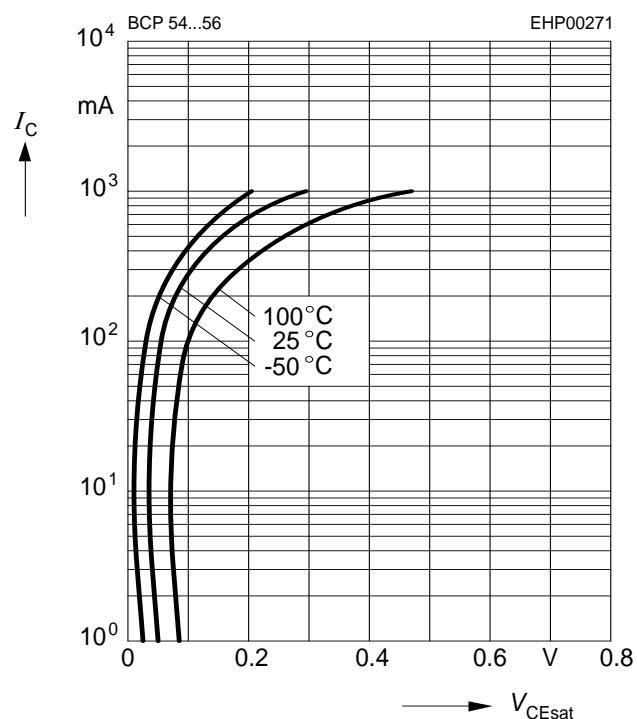
**Base-emitter saturation voltage**

$I_C = f(V_{BEsat}), h_{FE} = 10$



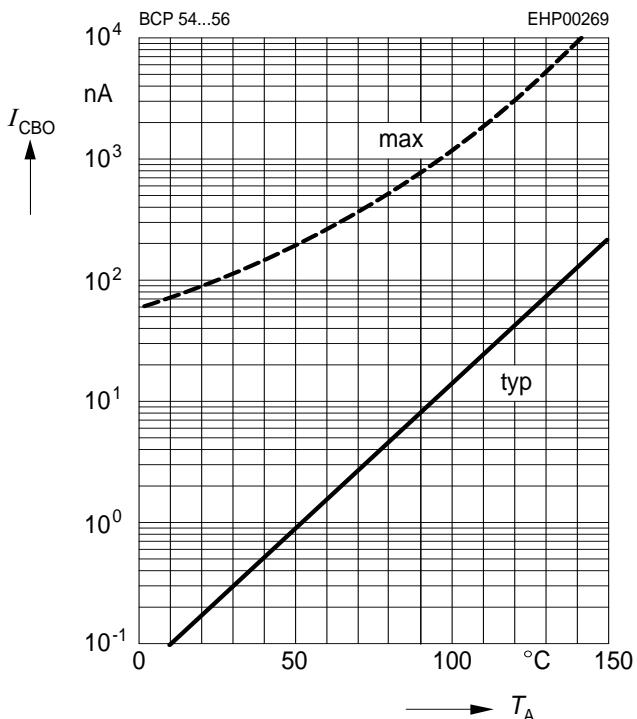
**Collector-emitter saturation voltage**

$I_C = f(V_{CEsat}), h_{FE} = 10$

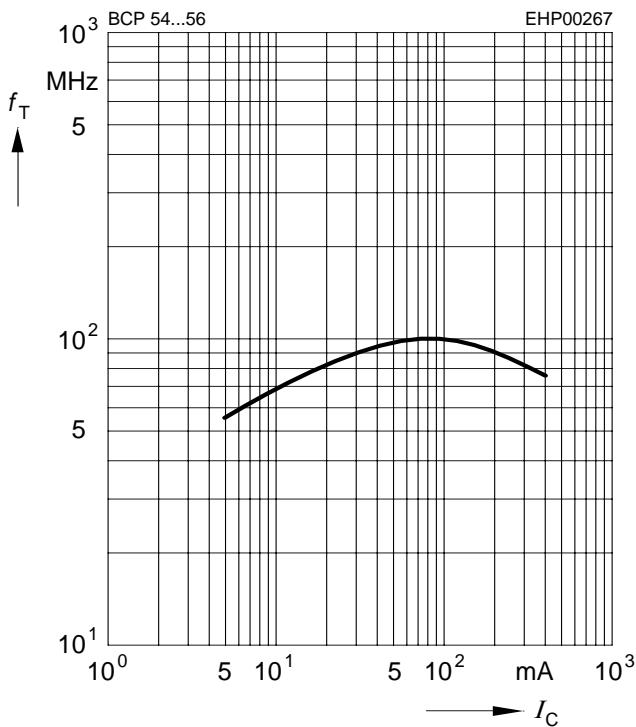


**Collector cutoff current  $I_{CBO} = f(T_A)$**

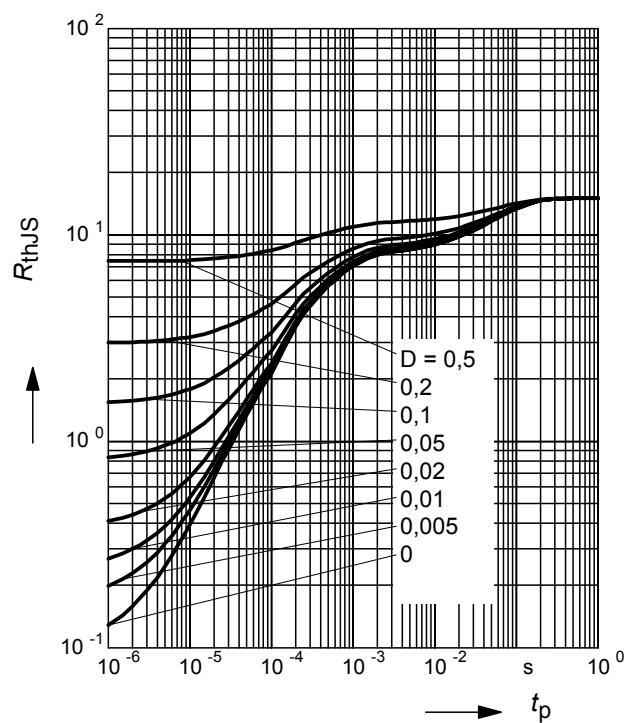
$V_{CBO} = 30 \text{ V}$



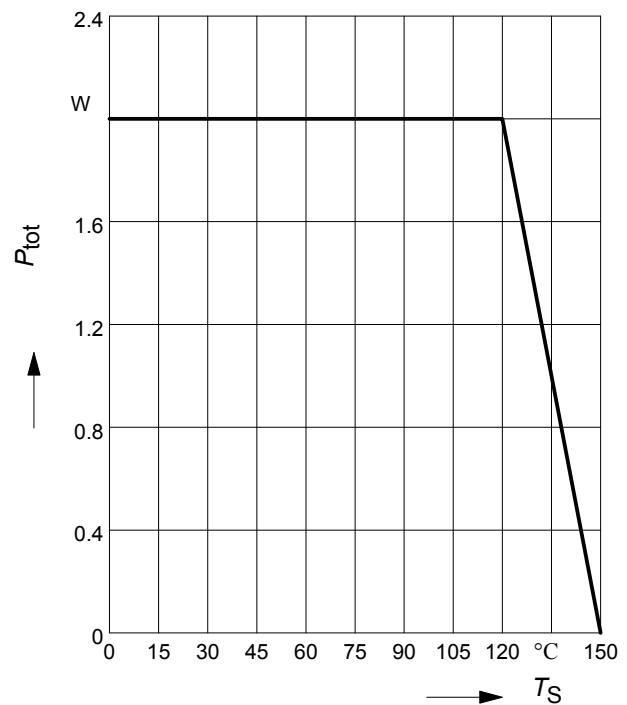
**Transition frequency**  $f_T = f(I_C)$   
 $V_{CE} = 10 \text{ V}$



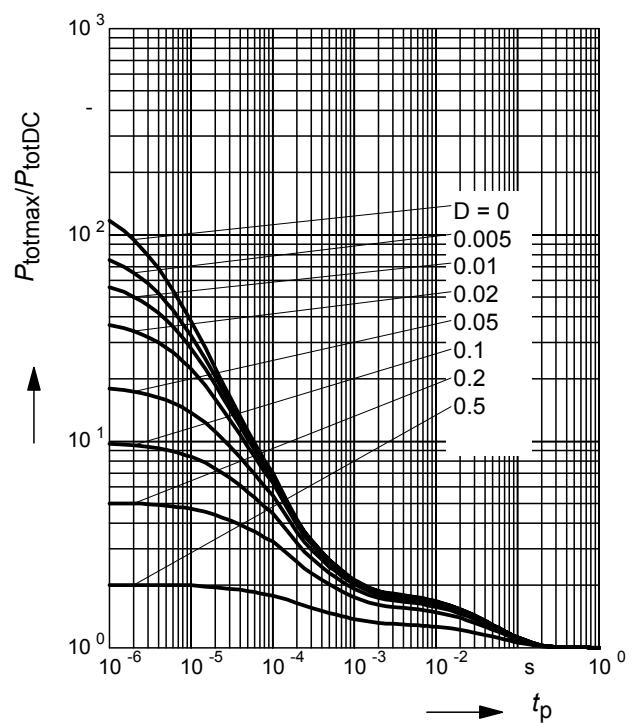
**Permissible Pulse Load**  $R_{thJS} = f(t_p)$



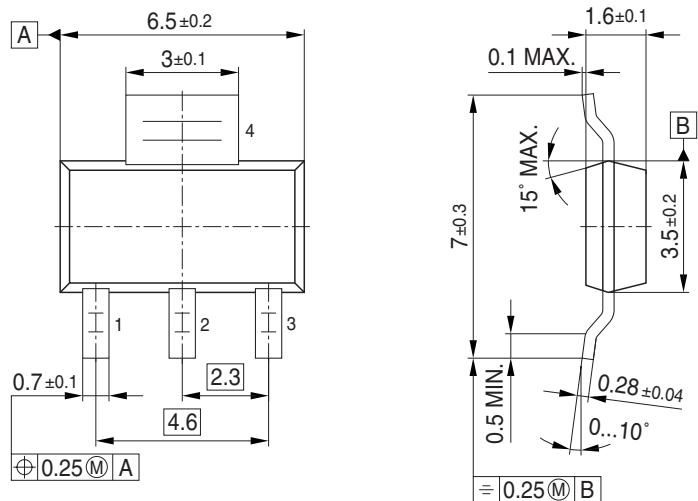
**Total power dissipation**  $P_{tot} = f(T_S)$



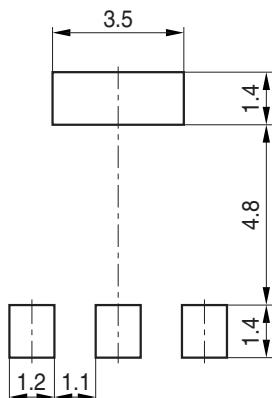
**Permissible Pulse Load**  
 $P_{totmax}/P_{totDC} = f(t_p)$



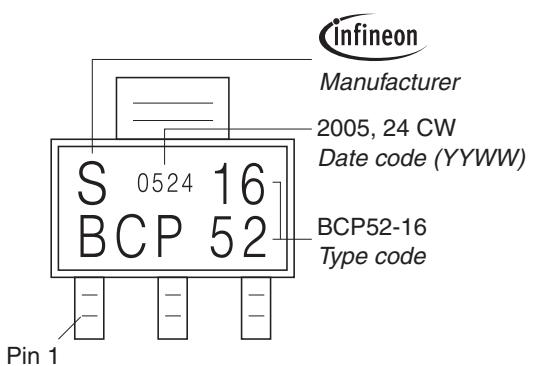
## Package Outline



## Foot Print

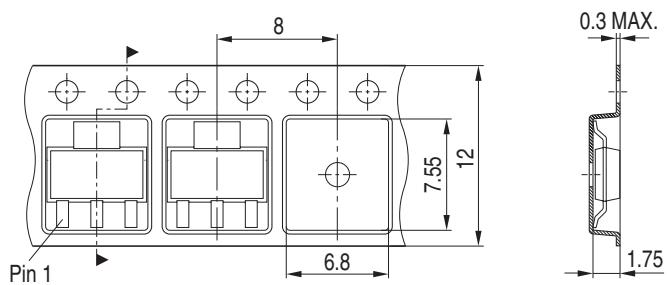


## Marking Layout (Example)



## Packing

Reel ø180 mm = 1.000 Pieces/Reel  
Reel ø330 mm = 4.000 Pieces/Reel



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